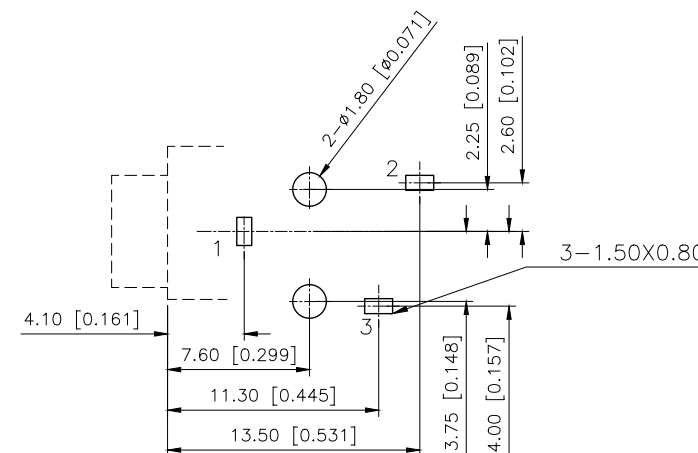
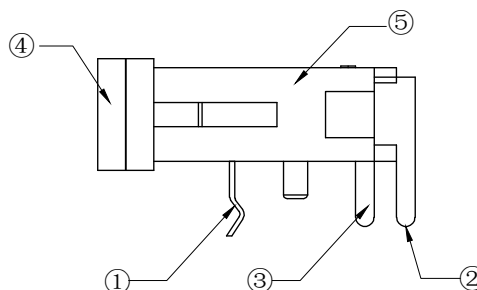
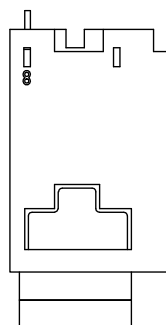
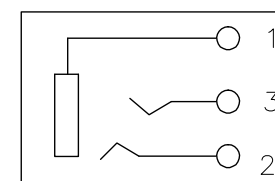


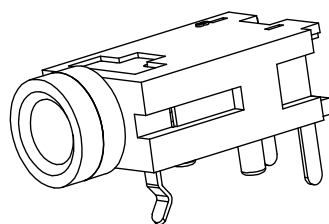
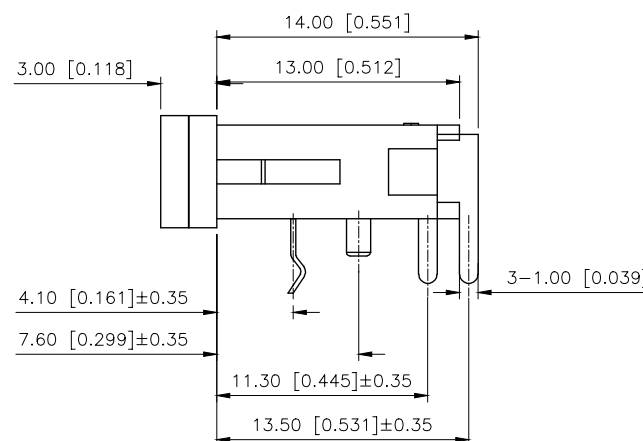
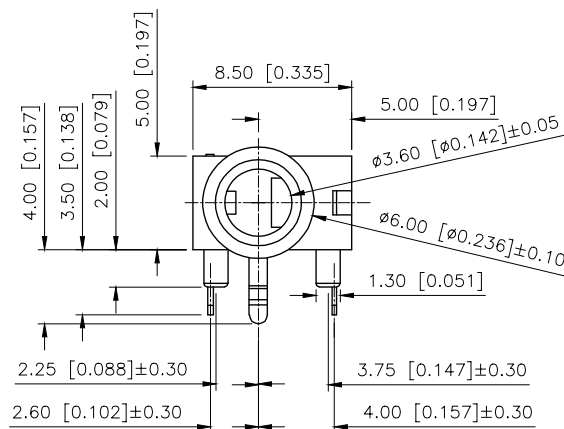
	REVISIONS				
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A0	N/A		INITIAL RELEASE	/	/
A1	N/A		参照实物修正图纸，图面升级整理图面	2024.9.12	阿树



PCB LAYOUT TOP VIEW



CIRCUIT DIAGRAM



SPECIFICATIONS:

- 1.Rating : DC 30V 0.5A:
- 2.Contact resistance: $\leq 30\text{m}\Omega$
- 3.Insulation resistance: $\geq 100\text{M}\Omega(\text{DC}250\text{V})$
- 4.Withstand voltage: 500VAC :
- 5.Insertion and extraction force:3–25N
- 6.life test:5,000 cycles.

5	Housing	1	PA	Black
4	Copper sleeve	1	Brass	
3	3# Terminal	1	Phosphor Bronze	T=0.25
2	2# Terminal	1	Phosphor Bronze	T=0.30
1	1# Terminal	1	Brass	T=0.25
NO	PRART NAME	QTY	MATERIAL	SPECIFICATION

AuGLAR	$\pm 5^\circ$
X.	± 0.40
X.x	± 0.30
X.xx	± 0.20
X.xxx	± 0.15
UNSPECIFIED TOLERANCES	



DESIGN	阿树	VIEW: 	MODEL TYPE: 3.5 PHONE JACK
CHECKED		UNIT: mm/in	PART NO.: PJ-319
APPROVED		SIZE: A4	DWG NO.: X-PJ-319

SCALE	PAGE	REVISION
N/A	1/1	A1